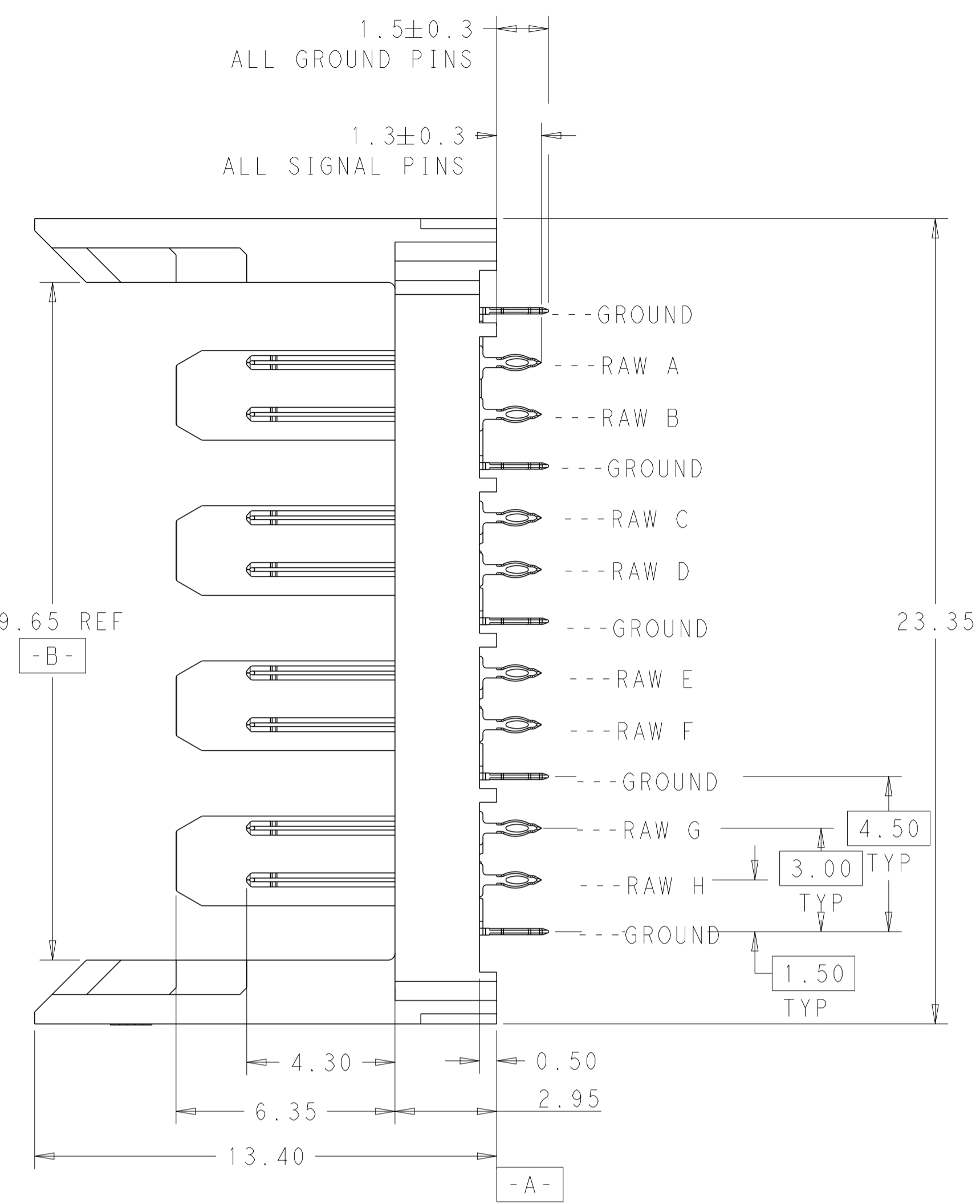
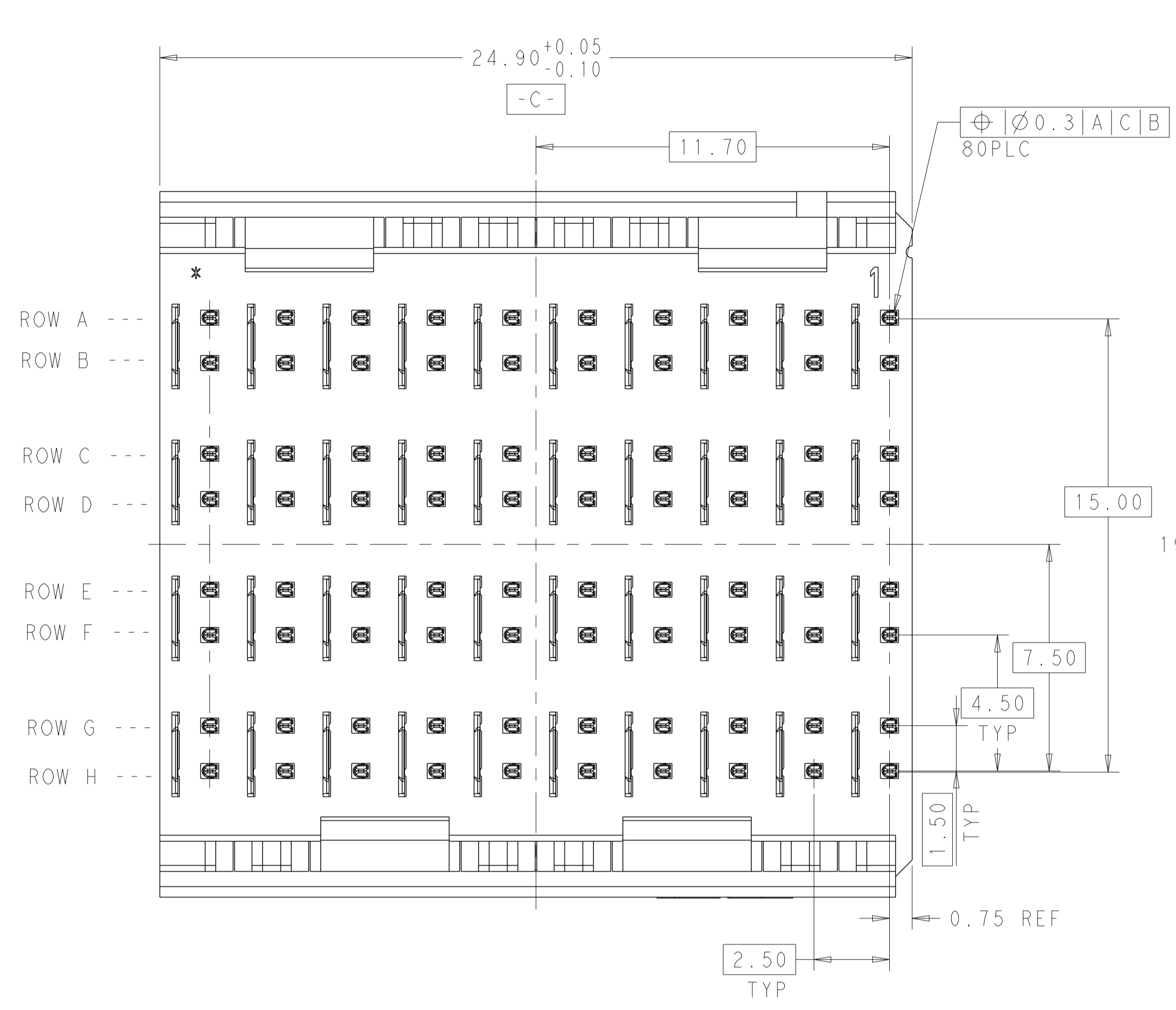
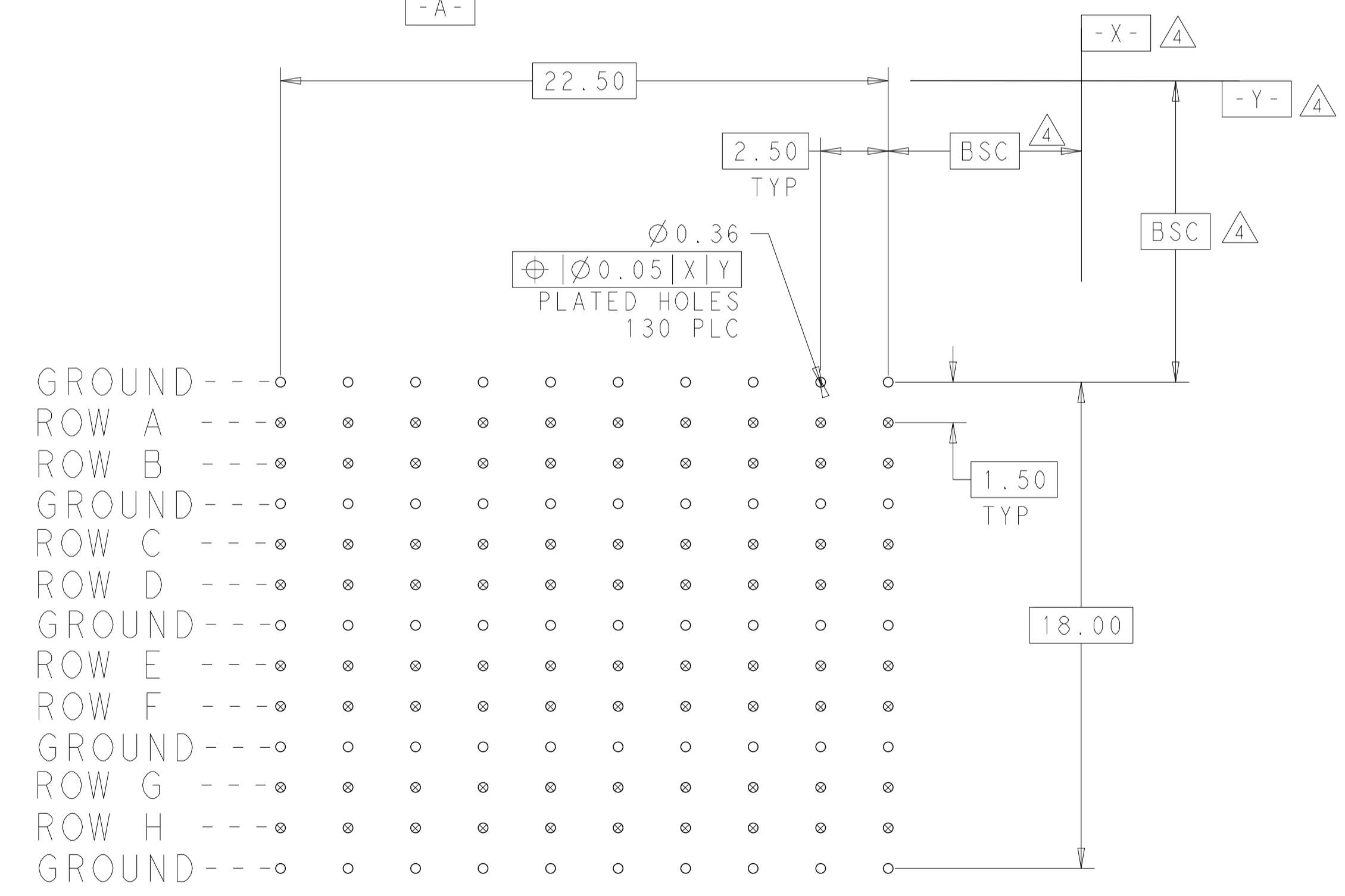
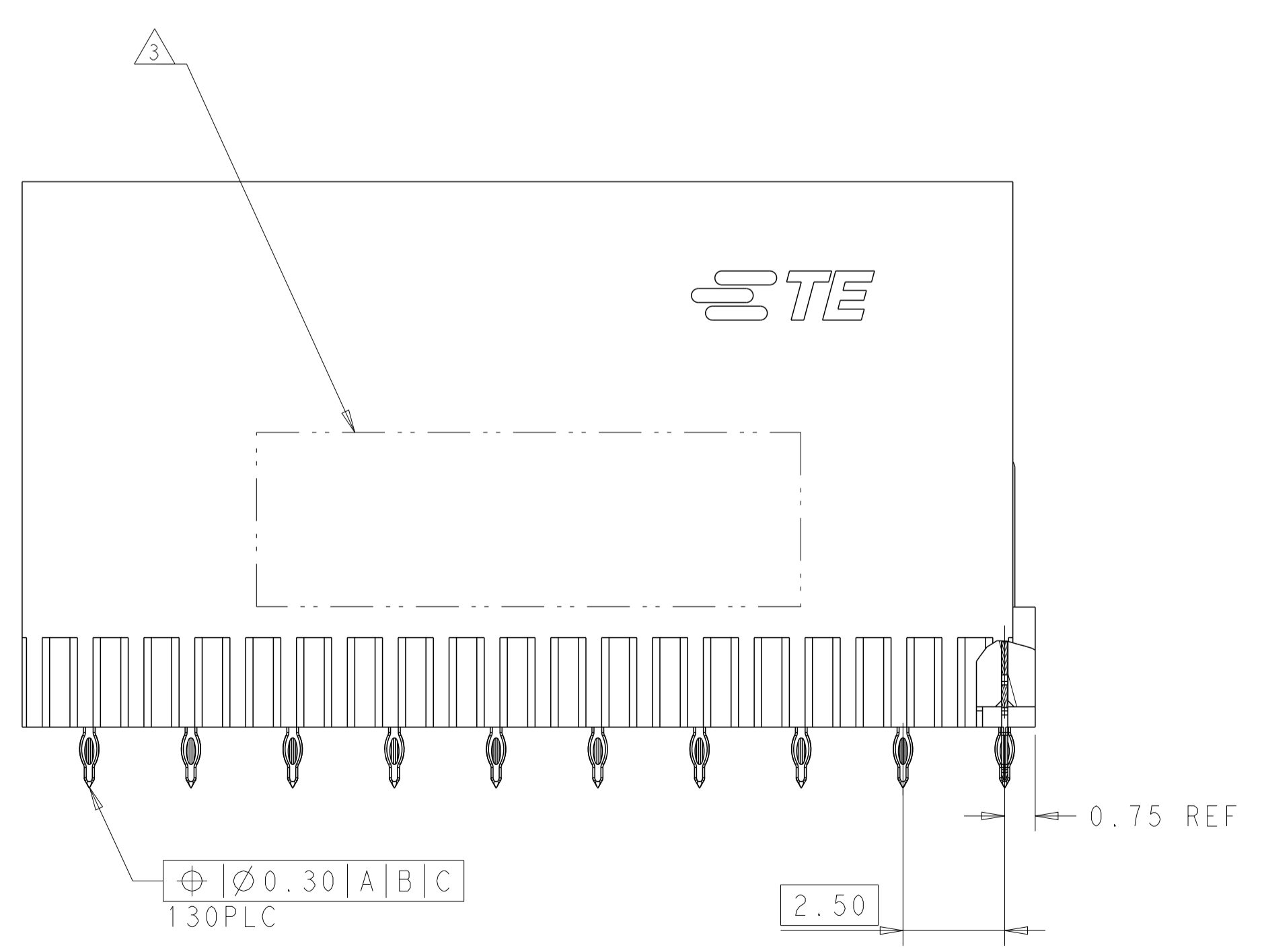


REVISIONS				
P.	LTN.	DESCRIPTION	DATE	APVD.
A		INITIAL RELEASE	19MAR15	D.S. F.Y.



- 1 MATERIAL:  
CONTACT AND SHIELD: COPPER ALLOY  
HOUSING: THERMALPLASTIC, UL 94V-0
- 2 FINISH: SIGNAL AND GROUND CONTACTS:  
MATING AREA: MEETS THE PERFORMANCE REQUIREMENTS OF  
PRODUCT SPECIFICATION 108-60103; BASED ON TELCORDIA  
GR-1217-CORE, APPLICATIONS IN UNCONTROLLED ENVIRONMENTS  
COMPLIANT PIN AREA: 0.5  $\mu\text{m}$  MIN MATTE  
TIN OVER BASE PLATING
- 3 CONNECTOR MARKED WITH PART NUMBER AND DATE CODE
- 4 DATUMS AND BASIC DIMENSIONS ESTABLISHED BY CUSTOMER
- 5 CONTACT AREA LUBRICATED WITH BELLCORE  
APPROVED LUBRICANT. TECHNICAL REFERENCE:  
GR-1217-CORE, ISSUE 2, DECEMBER 2008.
- 6 RECOMMENDED THRU HOLE DIAMETER AND PLATING THICKNESSES PLEASE  
REFER TO APPLICATION SPEC 114-13059



RECOMMENDED PCB LAYOUT  
===== VIEW FROM COMPONENT SIDE =====

2170902-1  
PART NUMBER

SECTION J-J

THIS DRAWING IS A CONTROLLED DOCUMENT.		OWN: DAVID SHEN 18DECT4	TE Connectivity
DIMENSIONS: mm		CHK: FRANK YANG 18DECT4	
TOLERANCES UNLESS OTHERWISE SPECIFIED:		APVD: FRANK YANG 18DECT4	NAME: ASSEMBLY DRAWING, HM-eZD+ VERTICAL, HEADER, 4PAIRS 10COLUMNS
0 PLC ±: 0.2 1 PLC ±: 0.1 3 PLC ±: 0.05 4 PLC ±: 0.05 ANGLES ±: 0.1		PRODUCT SPEC: 108-60103	
MATERIAL:		APPLICATION SPEC: 114-13059	SIZE: A1
FINISH:		WEIGHT:	RESTRICTED TO: -
		Customer Drawing	SCALE: - SHEET 1 OF 1 REV A

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